Amendment dated October 29, 2003

Reply to Office action dated September 25, 2003

Amendments To The Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Original) A microlithographic mask for forming a sub-resolution feature in

photoresist with an acceptable process latitude, said mask comprising:

a layer of transparent material;

a layer of light-obstructing material; and

a layer of attenuating phase shifting material located between said layer of

transparent material and said layer of light-obstructing material; and

wherein said layer of light-obstructing material and said layer of attenuating

phase shifting material are patterned to form a transparent hole, a partially transmissive

assist feature, and a light-obstructing frame located between said transparent hole and said

partially transmissive assist feature.

2. (Original) The mask of claim 1, wherein said transparent hole is a rectangle.

3. (Original) The mask of claim 2, wherein said light-obstructing frame includes

an opaque frame, and wherein said opaque frame surrounds said transparent hole.

4. (Original) The mask of claim 3, wherein said partially transmissive feature

includes a partially transmissive frame surrounding said opaque frame.

5. (Original) The mask of claim 4, wherein said layer of light-obstructing

material includes a layer of opaque material, and wherein said layer of opaque material

includes an opaque background surrounding said partially transmissive frame.

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6. (Original) The mask of claim 1, wherein said layer of transparent material includes quartz.

- 7. (Original) The mask of claim 6, wherein said layer of attenuating phase shifting material includes a material selected from the group consisting of MoSi, chromium fluoride, silicon nitride, titanium nitride, tantalum silicide and zirconium silicon oxide.
- 8. (Original) The mask of claim 7, wherein said attenuating phase shifting material is deposited on said quartz.
- 9. (Original) The mask of claim 7, wherein the transmissivity of said layer of attenuating phase shifting material relative to said layer of transparent material is in the range of from about 6% to 100%.
- 10. (Original) The mask of claim 7, wherein said layer of light-obstructing material includes chrome.
- 11. (Currently amended) The mask of claim 1, further comprising a partially transmissive frame, said layer of phase-shifting material being located between said transparent opening hole and partially transmissive frame.
- 12. (Original) A mask for forming a contact hole with a depth of focus of at least 0.4 µm, said mask comprising:
 - a first layer of material; and
 - a second layer of attenuating phase shifting material; and

wherein said first layer of material and said second layer of attenuating phase shifting material are patterned to form a transparent opening, a partially transmissive rim surrounding said opening, and sub-resolution assist features for preventing incident light from propagating through portions of said attenuating phase shifting material.

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13. (Original) The mask of claim 12, wherein said partially transmissive rim is arranged to phase shift said incident light by 180° or an odd multiple of 180°.

- 14. (Original) The mask of claim 13, wherein said sub-resolution assist features form polygonal corners on said partially transmissive rim.
- 15. (Original) The mask of claim 14, wherein said polygonal corners include square corners.
- 16. (Original) The mask of claim 14, wherein said polygonal corners form triangular corners.
- 17. (Original) The mask of claim 12, further comprising at least one opaque frame.
- 18. (Original) The mask of claim 12, further comprising at least one transparent frame.
- 19. (Original) The mask of claim 12, further comprising at least one opaque frame surrounding said partially transmissive rim.
- 20. (Original) The mask of claim 19, further comprising bars with ends that do not overlap each other.
- 21. (Original) The mask of claim 12, further comprising at least one transparent frame surrounding said partially transmissive frame.
- 22. (Original) The mask of claim 21, wherein said transparent frame is formed of bars with ends that do not overlap each other.

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23. (Original) A microlithographic mask, comprising:

transparent material; and

patterned opaque material and phase shifting material, said patterned materials defining an opening, an opaque frame surrounding said opening, sub-resolution bars surrounding said frame, and opaque corners located between sub-resolution bars.

- 24. (Original) The mask of claim 23, wherein said transparent material includes quartz.
- 25. (Original) The mask of claim 24, wherein said phase shifting material is partially transmissive relative to said transparent material.
- 26. (Original) The mask of claim 25, wherein said opaque material includes metal deposited on said phase shifting material.
- 27. (Original) The mask of claim 23, further comprising an opaque frame surrounding said sub-resolution bars, and partially transmissive bars surrounding said opaque frame.
- 28. (Original) A mask for forming an array of sub-resolution features, said mask comprising:
 - a layer of transparent material;
 - a layer of light-obstructing material; and
- a layer of attenuating phase shifting material located between said layer of transparent material and said layer of light-obstructing material; and

wherein said layer of light-obstructing material and said layer of attenuating phase shifting material are patterned to form transparent holes and light-obstructing frames surrounding said transparent holes.

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29. (Original) The mask of claim 28, further comprising partially transmissive features surrounding said light-obstructing frames.

- 30. (Original) The mask of claim 29, further comprising opaque corners on said partially transmissive features.
- 31. (Original) A multi-tone mask for forming sub-resolution features, said mask comprising:
- a first layer of attenuating phase shifting material, said layer defining openings corresponding to said sub-resolution features; and
- a second layer of material for preventing incident light from propagating through said first layer, said second layer including frames surrounding said openings, and wherein said second layer defines bar-shaped partially transmissive assist features.
- 32. (Currently amended) The mask of claim 31, wherein phase-shifted light transmitted through one of said bars bar-shaped partially transmissive assist features operatively interacts with light transmitted through said openings.
- 33. (Currently amended) A mask for forming an elliptical feature in photoresist, said mask comprising:
 - a layer of transparent material;
 - a layer of opaque material; and
- a layer of attenuating phase shifting material located between said layer of transparent material and said layer of opaque material; and

wherein said layer of opaque material and said layer of attenuating phase shifting material are patterned to form transparent holes and opaque frames surrounding said transparent holes.

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34. (Original) The mask of claim 33, further comprising an array of rectangular openings, and attenuating phase shifting bars located between said rectangular openings.

- 35. (Original) The mask of claim 34, further comprising a patterned layer of opaque material for defining said attenuating phase shifting bars.
- 36. (Original) The mask of claim 35, further comprising a transparent substrate for supporting said attenuating phase shifting bars and said patterned layer of opaque material.
- 37. (Original) A method of making a multi-tone microlithographic mask, said method comprising:

providing sets of dimension data representative of mask patterns;

for each set of dimension data, calculating feature dimension data as a function of optical conditions; and

for a desired optical condition, identifying the sets of dimension data that have feature dimension data within desired limits.

- 38. (Original) The method of claim 37, further comprising the step of selecting the one set of dimension data that achieves the smallest change in critical dimension between a zero defocus condition and a maximum considered defocus condition.
- 39. (Original) The method of claim 38, wherein said dimension data includes the widths of transparent openings in said patterns.
- 40. (Original) The method of claim 39, wherein said dimension data includes sub-resolution dimensions of opaque features in said patterns.
- 41. (Original) The method of claim 40, wherein said dimension data includes dimensions of partially transmissive phase shifting features in said patterns.

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42. (Original) The method of claim 41, wherein said limits include a critical dimension for an exposed feature.

- 43. (Original) The method of claim 42, wherein said limits operate to exclude side-lobing conditions.
- 44. (Original) The method of claim 43, further comprising the step of forming patterned layers of attenuating phase shifting material and light-obstructing material in accordance with said one set of dimension data.
- 45. (Original) The method of claim 44, wherein said light-obstructing material includes opaque material.
- 46. (Original) The method of claim 44, wherein said light-obstructing material includes partially transmissive material.
- 47. (Original) The method of claim 37, wherein said feature dimension data define opaque corner structures.
- 48. (Original) The method of claim 37, wherein said feature dimension data define partially transmissive corner structures.